

December 1994

LM129/LM329 Precision Reference

General Description

The LM129 and LM329 family are precision multi-current temperature-compensated 6.9V zener references with dynamic impedances a factor of 10 to 100 less than discrete diodes. Constructed in a single silicon chip, the LM129 uses active circuitry to buffer the internal zener allowing the device to operate over a 0.5 mA to 15 mA range with virtually no change in performance. The LM129 and LM329 are available with selected temperature coefficients of 0.001, 0.002, 0.005 and 0.01%/°C. These new references also have excellent long term stability and low noise.

A new subsurface breakdown zener used in the LM129 gives lower noise and better long-term stability than conventional IC zeners. Further the zener and temperature compensating transistor are made by a planar process so they are immune to problems that plague ordinary zeners. For example, there is virtually no voltage shift in zener voltage due to temperature cycling and the device is insensitive to stress on the leads.

The LM129 can be used in place of conventional zeners with improved performance. The low dynamic impedance simplifies biasing and the wide operating current allows the replacement of many zener types.

The LM129 is packaged in a 2-lead TO-46 package and is rated for operation over a -55°C to $+125^{\circ}\text{C}$ temperature range. The LM329 for operation over 0°C to 70°C is available in both a hermetic TO-46 package and a TO-92 epoxy package.

Features

- 0.6 mA to 15 mA operating current
- 0.6Ω dynamic impedance at any current
- Available with temperature coefficients of 0.001%/°C
- 7µV wideband noise
- 5% initial tolerance
- 0.002% long term stability
- Low cost
- Subsurface zener

Connection Diagrams

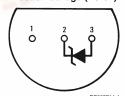
Metal Can Package (T0-46)



Pin 2 is electrically connected to case

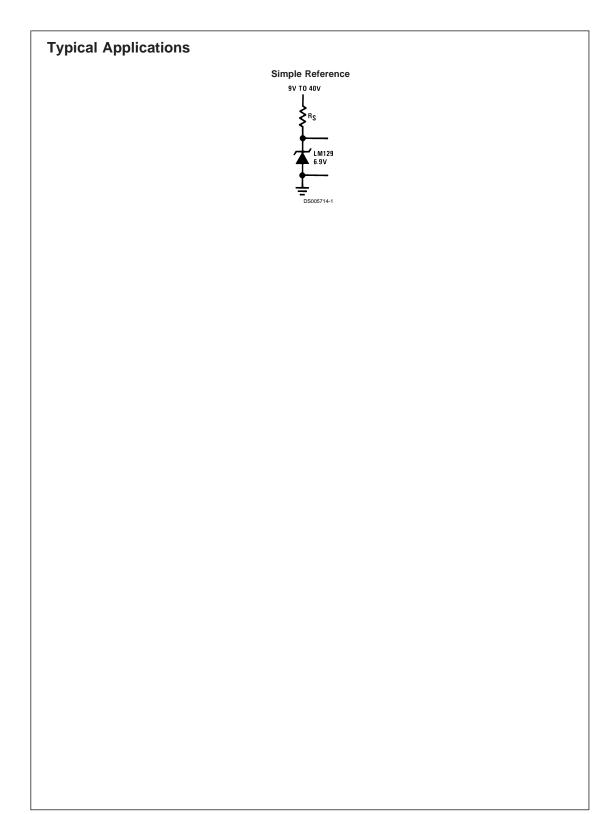
Bottom View
Order Number LM129AH, LM129AH/883, LM129BH,
LM129BH/883, LM129CH, LM329AH, LM329BH,
LM329CH or LM329DH
See NS Package H02A

Plastic Package (TO-92)



Bottom View Order Number LM329BZ, LM329CZ or LM329DZ See NS Package Z03A





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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications. (Note 3)

Reverse Breakdown Current

Forward Current

Operating Temperature Range

LM129 LM329

Storage Temperature Range Soldering Information

TO-92 package: 10 sec. TO-46 package: 10 sec. -55°C to +125°C 0°C to +70°C -55°C to +150°C

260°C 300°C

Electrical Characteristics (Note 2)

Parameter	Conditions	LM129A, B, C			LM329A, B, C, D			Units
i didilictei		Min	Тур	Max	Min	Тур	Max	. Onles
Reverse Breakdown Voltage	T _A = 25°C,							
	0.6 mA ≤ I _R ≤ 15 mA	6.7	6.9	7.2	6.6	6.9	7.25	V
Reverse Breakdown Change	T _A = 25°C,							
with Current (Note 4)	0.6 mA ≤ I _R ≤ 15 mA		9	14		9	20	mV
Reverse Dynamic Impedance	$T_A = 25^{\circ}C, I_R = 1 \text{ mA}$		0.6	1		0.8	2	Ω
(Note 4)								
RMS Noise	$T_A = 25^{\circ}C$							
	10 Hz ≤ F ≤ 10 kHz		7	20		7	100	μV
Long Term Stability	$T_A = 45^{\circ}C \pm 0.1^{\circ}C,$							
(1000 hours)	$I_R = 1 \text{ mA} \pm 0.3\%$		20			20		ppm
Temperature Coefficient	I _R = 1 mA							
LM129A, LM329A			6	10		6	10	ppm/°C
LM129B, LM329B			15	20		15	20	ppm/°C
LM129C, LM329C			30	50		30	50	ppm/°C
LM329D						50	100	ppm/°C
Change In Reverse Breakdown	1 mA ≤ I _R ≤ 15 mA		1			1		ppm/°C
Temperature Coefficient								
Reverse Breakdown Change	1 mA ≤ I _R ≤ 15 mA		12			12		mV
with Current								
Reverse Dynamic Impedance	1 mA ≤ I _R ≤ 15 mA		0.8			1		Ω

30 mA

2 mA

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

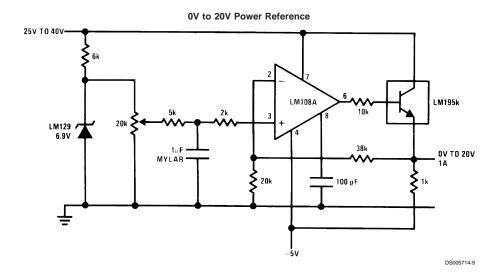
Note 2: These specifications apply for $-55^{\circ}\text{C} \le \text{T}_{A} \le +125^{\circ}\text{C}$ for the LM129 and $0^{\circ}\text{C} \le \text{T}_{A} \le +70^{\circ}\text{C}$ for the LM329 unless otherwise specified. The maximum junction temperature for an LM129 is 150°C and LM329 is 100°C. For operating at elevated temperature, devices in TO-46 package must be derated based on a thermal resistance of 440°C/W junction to ambient or 80°C/W junction to case. For the TO-92 package, the derating is based on 180°C/W junction to ambient with 0.4" leads from a PC board and 160°C/W junction to ambient with 0.125" lead length to a PC board.

Note 3: Refer to RETS129H for LM129 family military specifications.

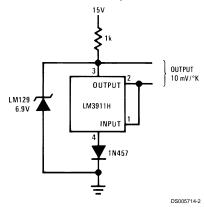
Note 4: These changes are tested on a pulsed basis with a low duty-cycle. For changes versus temperature, compute in terms of tempco.

Typical Applications Low Cost 0-25V Regulator LM317 150 -10V DS005714-7 Adjustable Bipolar Output Reference 15V $\begin{array}{l} \textbf{-0UTPUT} \\ \textbf{-6.9} \leq \textbf{V}_{\textbf{OUT}} \leq \textbf{6.9} \end{array}$ LM108A 10 TURN OUTPUT ADJUST LM129 7 30 pF

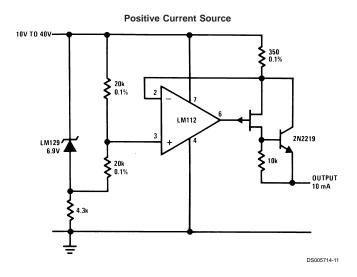
Typical Applications (Continued)



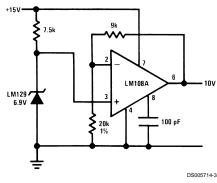
External Reference for Temperature Transducer



Typical Applications (Continued)

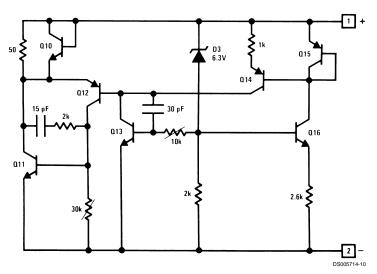


Buffered Reference with Single Supply



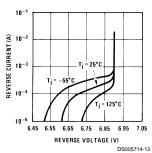
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Schematic Diagram

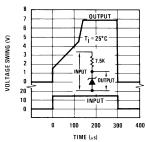


Typical Performance Characteristics

Reverse Characteristics

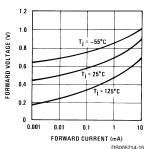


Response Time

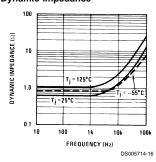


DS005714-14

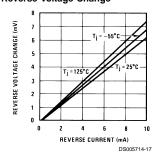
Forward Characteristics



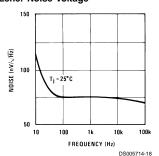
Dynamic Impedance



Reverse Voltage Change



Zener Noise Voltage

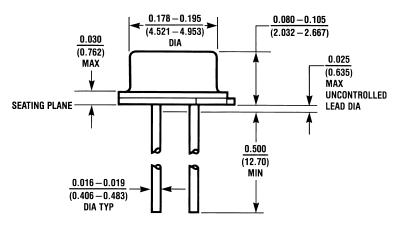


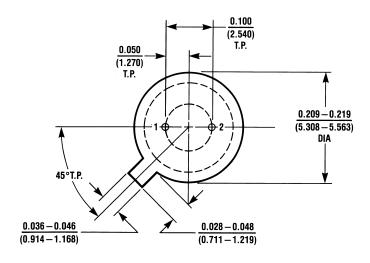
Typical Performance Characteristics (Continued) Low Frequency Noise Voltage 0.01 Hz < f < 1 Hz

DS005714-5

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Physical Dimensions inches (millimeters) unless otherwise noted

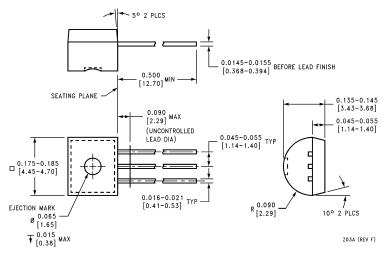




H02A (REV C)

Metal Can Package Order Number LM129AH, LM129AH/883, LM129BH, LM129BH/883, LM129CH, LM329AH, LM329BH, LM329CH, or LM329DH NS Package H02A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Plastic Package Order Number LM329BZ, LM329CZ, or LM329DZ NS Package Z03A

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National Semiconductor Corporation Americas

Tel: 1-800-272-9959 Fax: 1-800-737-7018 Email: support@nsc.com

www.national.com

National Semiconductor Europe

Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 1 80-530 85 85
English Tel: +49 (0) 1 80-532 78 32
Français Tel: +49 (0) 1 80-532 93 58
Italiano Tel: +49 (0) 1 80-534 16 80

National Semiconductor Asia Pacific Customer Response Group Tel: 65-2544466 Fax: 65-2504466

Email: sea.support@nsc.com

National Semiconductor Japan Ltd. Tel: 81-3-5639-7560 Fax: 81-3-5639-7507